L Number	Hits	Search Text	DB	Time stamp
1	11	liu-wen-chun.in.	USPAT; US-PGPUB; EPO; JPO;	2003/10/23 14:59
2	6	lai-chien-hung.in.	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2003/10/23 14:59
-	6	(("5752182") or ("6399415") or ("5741729")).PN.	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2003/10/22 15:25
_	177	Ueno-Yutaka.in.	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2003/10/22
_	1116	substrate with concave and (chip die IC) and wir\$5	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/10/22
-	187	substrate with concave and (chip die IC) and wir\$5 and dic\$4	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/10/22 16:01
_	4	("5298768" "5475241" "5814837" "5841177").PN.	IBM_TDB USPAT	2003/10/22
-	261	substrate with concave and (metal electrode) and expos\$5 and dic\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/10/22
-	1	257/99-100.ccls. and substrate with concave and (metal electrode) and expos\$5 and dic\$4	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/10/22 17:42
-	9	257/99-100.ccls. and substrate with concave and (metal electrode) and expos\$5	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/10/22
-	10	257/678,711.ccls. and substrate with concave and (metal electrode) and expos\$5	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/10/22 17:44
_	3	257/730.ccls. and substrate with concave and (metal electrode) and expos\$5	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/10/22
_	3	257/618-622.ccls. and substrate with concave and (metal electrode) and expos\$5 and dic\$4	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/10/22 18:44
-	5	("4670770" "5019943" "6020603" "6049124" "6091130"	IBM_TDB USPAT	2003/10/22 17:54
_	5	"2001/0011772").PN. 257/695-696.ccls. and substrate with concave and (metal electrode) and expos\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/10/22 18:46

		1 257 /720 2 1 1 1	1	T 0 0 0 7 / 1 0 / 0 0
\	3	257/730.ccls. and substrate with concave	USPAT;	2003/10/22
		and (metal electrode) and expos\$5	US-PGPUB;	18:47
			EPO; JPO;	1
			DERWENT;	1
1			IBM_TDB	1
-	13		USPAT;	2003/10/22
	!	and (metal electrode) and expos\$5	US-PGPUB;	19:04
			EPO; JPO;	
			DERWENT;	1
			IBM TDB	
_	2	("6383835").PN.	USPAT;	2003/10/22
			US-PGPUB;	18:54
			EPO; JPO;	
	İ		DERWENT;	1
			IBM TDB	
_	8	("4924282" "5079190" "5081347"	USPAT	2003/10/22
		"5098630" "5438216" "5440451"		18:56
		"5729437" "5912504").PN.	1	1 20.00
_	0		USPAT;	2003/10/22
1		substrate) with concave	US-PGPUB;	19:05
		Substitute, with contave	EPO; JPO;	1 13.03
			DERWENT;	1
ļ			IBM TDB	
_	17	(multilayer adj substrate) with concave	USPAT;	2003/10/22
	1/	(multilayer au) substrace, with concave	US-PGPUB;	19:19
			EPO; JPO;	13,19
			DERWENT;	1
			1	
1	372		IBM_TDB	2002/10/22
_	3/2	multilayer with concave	USPAT;	2003/10/22
)			US-PGPUB;	19:09
			EPO; JPO;	
l l			DERWENT;]
			IBM_TDB	
-	41	Hata-fumio.in.	USPAT;	2003/10/22
			US-PGPUB;	19:21
}	İ		EPO; JPO;	
, j			DERWENT;	1
ł			IBM_TDB]
- }	7	Komori-hisatane.in.	USPAT;	2003/10/23
			US-PGPUB;	14:58
ì			EPO; JPO;	1
			DERWENT;	
			IBM_TDB	